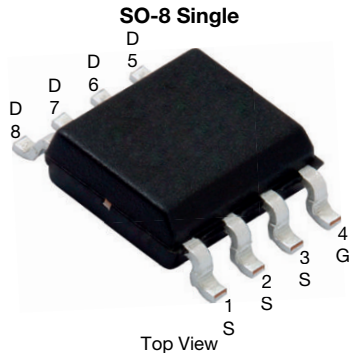


P-Channel 30 V (D-S) MOSFET

PRODUCT SUMMARY			
V _{DS} (V)	R _{DS(on)} (Ω) MAX.	I _D (A) ^d	Q _g (TYP.)
-30	0.0062 at V _{GS} = -10 V	-25.3	54 nC
	0.0074 at V _{GS} = -6 V	-23.2	
	0.0092 at V _{GS} = -4.5 V	-20.8	



FEATURES

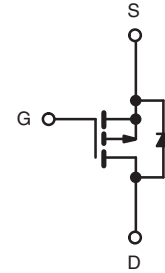
- TrenchFET® power MOSFET
- 100 % R_g and UIS tested
- Material categorization:
For definitions of compliance please see www.vishay.com/doc?99912



RoHS
COMPLIANT
HALOGEN
FREE

APPLICATIONS

- Adaptor switch, load switch
- Power management
- Notebook computers



P-Channel MOSFET

Ordering Information:

Si4143DY-T1-GE3 (lead (Pb)-free and halogen-free)

ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)				
PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-Source Voltage	V _{DS}	-30	V	
Gate-Source Voltage	V _{GS}	± 25		
Continuous Drain Current (T _J = 150 °C)	I _D	T _C = 25 °C	-25.3	
		T _C = 70 °C	-20.2	
		T _A = 25 °C	-17.7 ^{a, b}	
		T _A = 70 °C	-14.1 ^{a, b}	
Pulsed Drain Current (t = 300 μs)	I _{DM}	-70	A	
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C		-5
		T _A = 25 °C		-2.4 ^{a, b}
Avalanche Current	L = 0.1 mH	I _{AS}	-30	
Single Pulse Avalanche Energy	E _{AS}	45	mJ	
Maximum Power Dissipation	P _D	T _C = 25 °C	6	
		T _C = 70 °C	3.8	
		T _A = 25 °C	2.9 ^{a, b}	
		T _A = 70 °C	1.9 ^{a, b}	
Operating Junction and Storage Temperature Range	T _J , T _{stg}	-55 to 150	°C	

THERMAL RESISTANCE RATINGS					
PARAMETER		SYMBOL	TYPICAL	MAXIMUM	UNIT
Maximum Junction-to-Ambient ^{a, c}	t ≤ 10 s	R _{thJA}	36	43	°C/W
Maximum Junction-to-Foot	Steady State	R _{thJF}	16	21	

Notes

- Surface mounted on 1" x 1" FR4 board.
- t = 10 s.
- Maximum under steady state conditions is 84 °C/W.
- Based on T_C = 25 °C.



SPECIFICATIONS (T _J = 25 °C, unless otherwise noted)						
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static						
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} = 0 V, I _D = -250 μA	-30	-	-	V
V _{DS} Temperature Coefficient	ΔV _{DS} /T _J	I _D = -250 μA	-	-23	-	mV/°C
V _{GS(th)} Temperature Coefficient	ΔV _{GS(th)} /T _J		-	4.9	-	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} = V _{GS} , I _D = -250 μA	-1	-	-2.5	V
Gate-Source Leakage	I _{GSS}	V _{DS} = 0 V, V _{GS} = ± 25 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = -30 V, V _{GS} = 0 V	-	-	-1	μA
		V _{DS} = -30 V, V _{GS} = 0 V, T _J = 55 °C	-	-	-5	
On-State Drain Current ^a	I _{D(on)}	V _{DS} ≥ -10 V, V _{GS} = -10 V	-30	-	-	A
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = -10 V, I _D = -12 A	-	0.0051	0.0062	Ω
		V _{GS} = -6 V, I _D = -8 A	-	0.0061	0.0074	
		V _{GS} = -4.5 V, I _D = -5 A	-	0.0076	0.0092	
Forward Transconductance ^a	g _{fs}	V _{DS} = -10 V, I _D = -15 A	-	64	-	S
Dynamic ^b						
Input Capacitance	C _{iss}	V _{DS} = -15 V, V _{GS} = 0 V, f = 1 MHz	-	6630	-	pF
Output Capacitance	C _{oss}		-	750	-	
Reverse Transfer Capacitance	C _{rss}		-	710	-	
Total Gate Charge	Q _g	V _{DS} = -15 V, V _{GS} = -10 V, I _D = -18 A	-	111	167	nC
			-	54	81	
Gate-Source Charge	Q _{gs}	V _{DS} = -15 V, V _{GS} = -4.5 V, I _D = -18 A	-	19.5	-	
Gate-Drain Charge	Q _{gd}		-	15.5	-	
Gate Resistance	R _g	f = 1 MHz	0.5	2.3	4.6	Ω
Turn-On Delay Time	t _{d(on)}	V _{DD} = -15 V, R _L = 1.5 Ω I _D ≅ -10 A, V _{GEN} = -10 V, R _g = 1 Ω	-	18	27	ns
Rise Time	t _r		-	8	16	
Turn-Off Delay Time	t _{d(off)}		-	71	107	
Fall Time	t _f		-	15	23	
Turn-On Delay Time	t _{d(on)}	V _{DD} = -15 V, R _L = 1.5 Ω I _D ≅ -10 A, V _{GEN} = -4.5 V, R _g = 1 Ω	-	59	89	
Rise Time	t _r		-	60	90	
Turn-Off Delay Time	t _{d(off)}		-	56	84	
Fall Time	t _f		-	29	44	
Drain-Source Body Diode Characteristics						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C	-	-	-5	A
Pulse Diode Forward Current	I _{SM}		-	-	-70	
Body Diode Voltage	V _{SD}	I _S = -10 A, V _{GS} = 0 V	-	-0.78	-1.2	V
Body Diode Reverse Recovery Time	t _{rr}	I _F = -10 A, di/dt = 100 A/μs, T _J = 25 °C	-	42	63	ns
Body Diode Reverse Recovery Charge	Q _{rr}		-	37	56	nC
Reverse Recovery Fall Time	t _a		-	17	-	ns
Reverse Recovery Rise Time	t _b		-	25	-	

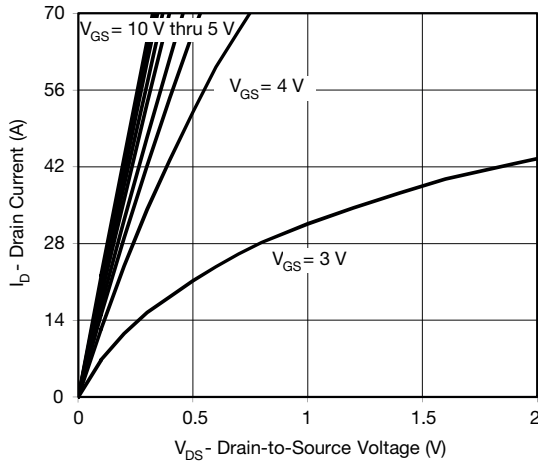
Notes

- a. Pulse test; pulse width ≤ 300 μs, duty cycle ≤ 2 %.
- b. Guaranteed by design, not subject to production testing.

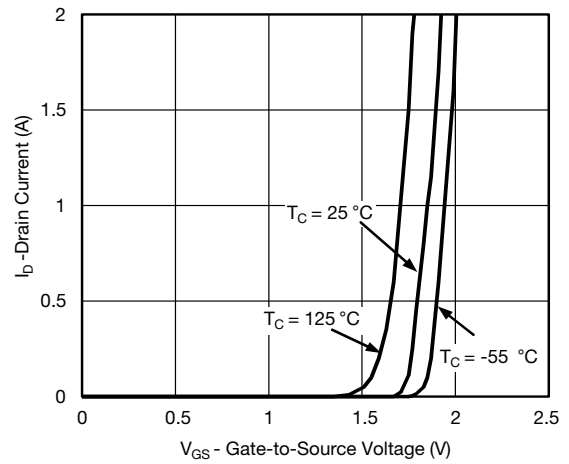
Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



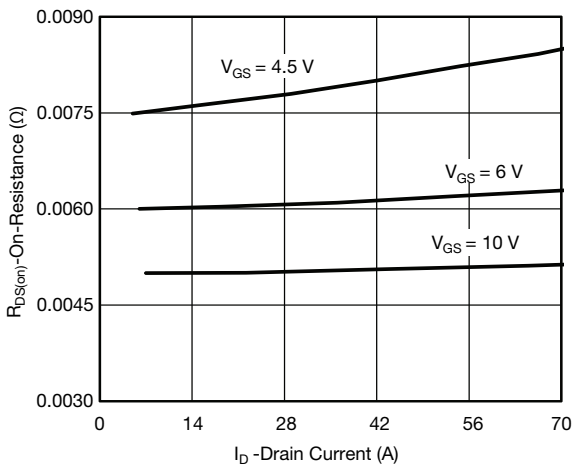
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



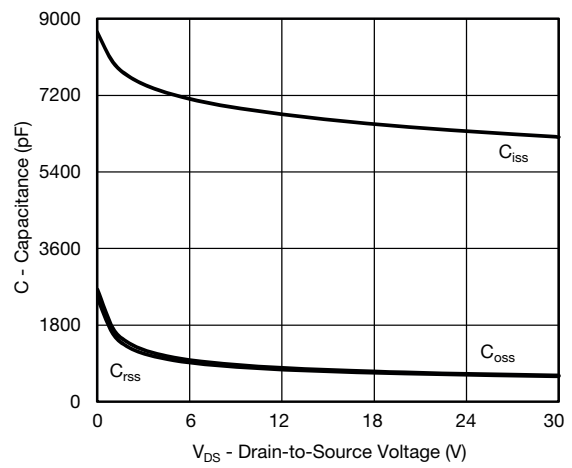
Output Characteristics



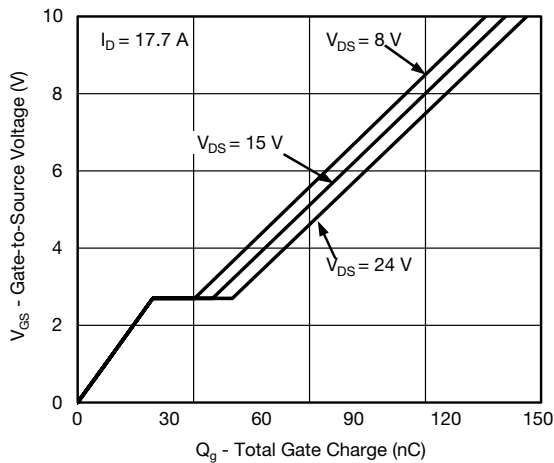
Transfer Characteristics



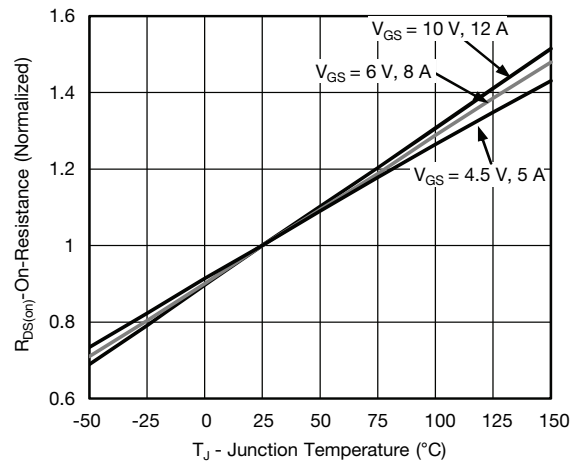
On-Resistance vs. Drain Current



Capacitance



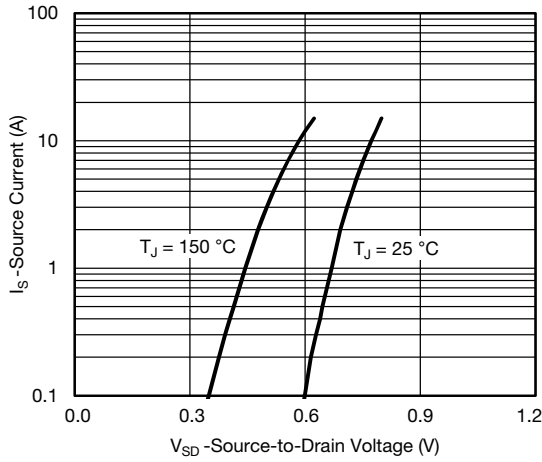
Gate Charge



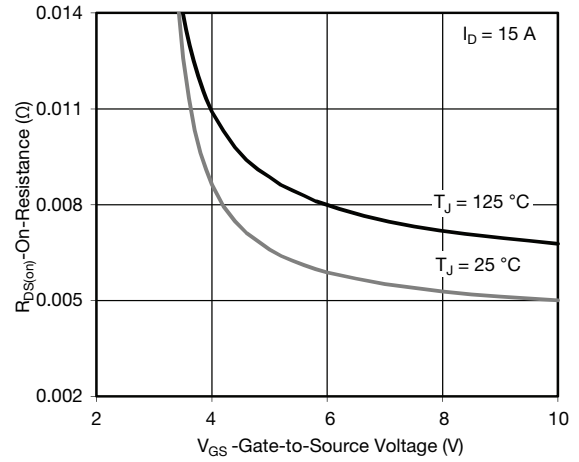
On-Resistance vs. Junction Temperature



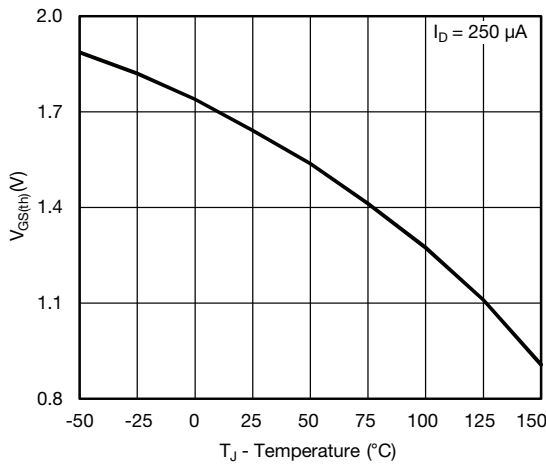
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



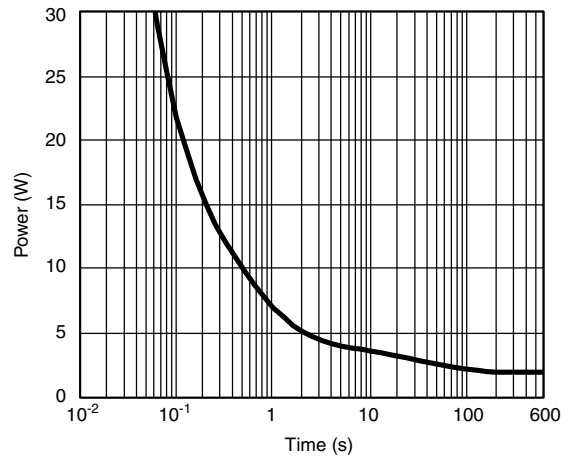
Source-Drain Diode Forward Voltage



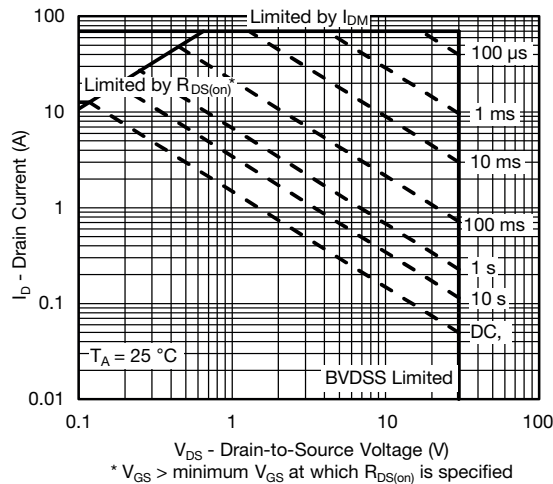
On-Resistance vs. Gate-to-Source Voltage



Threshold Voltage



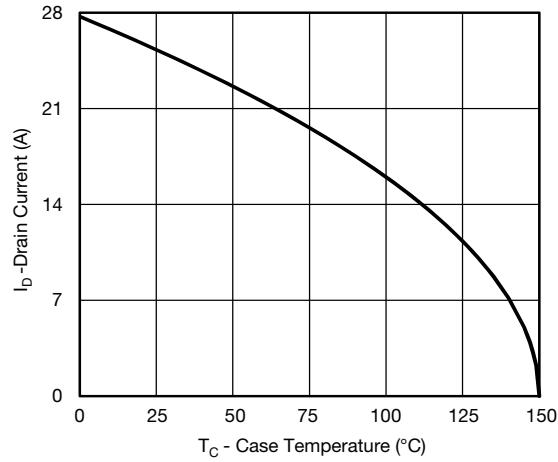
Single Pulse Power, Junction-to-Ambient



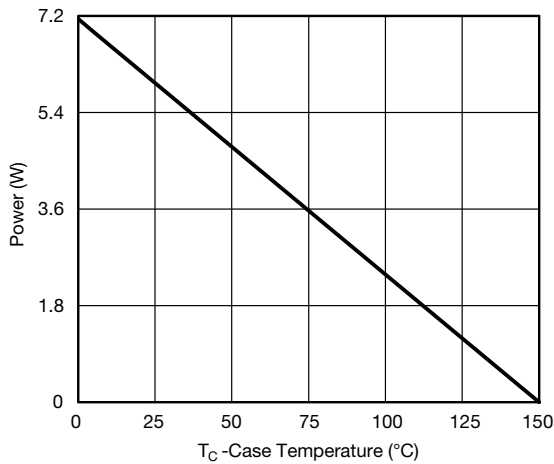
Safe Operating Area



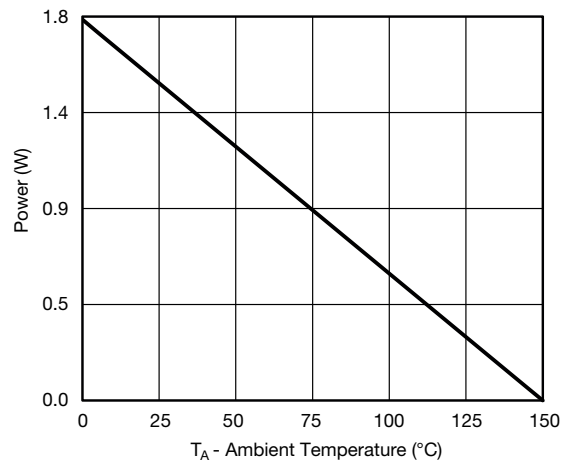
TYPICAL CHARACTERISTICS (T_J = 25 °C, unless otherwise noted)



Current Derating*



Power Derating, Junction-to-Foot

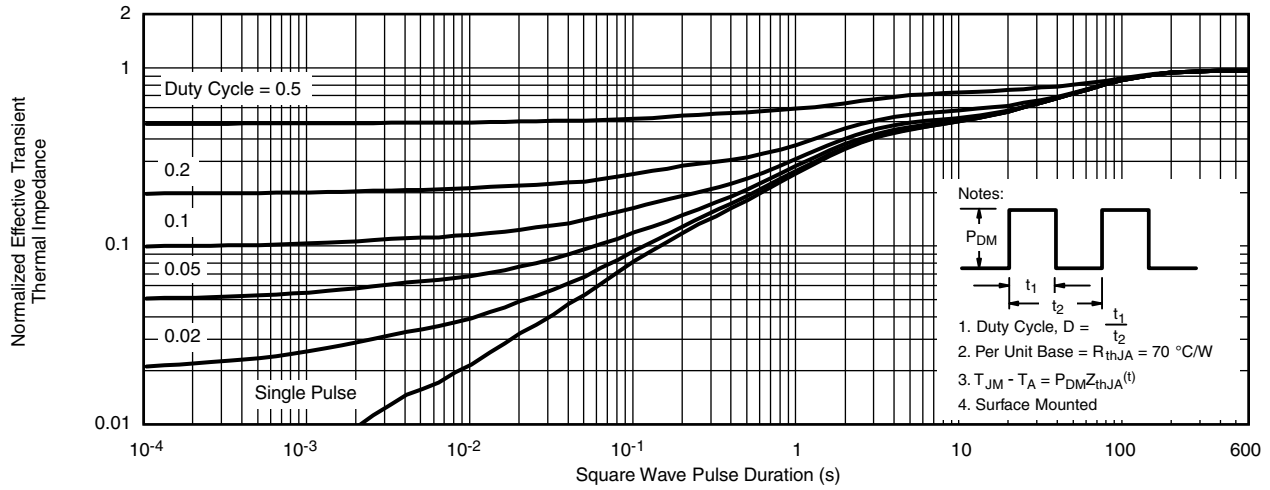


Power Derating, Junction-to-Ambient

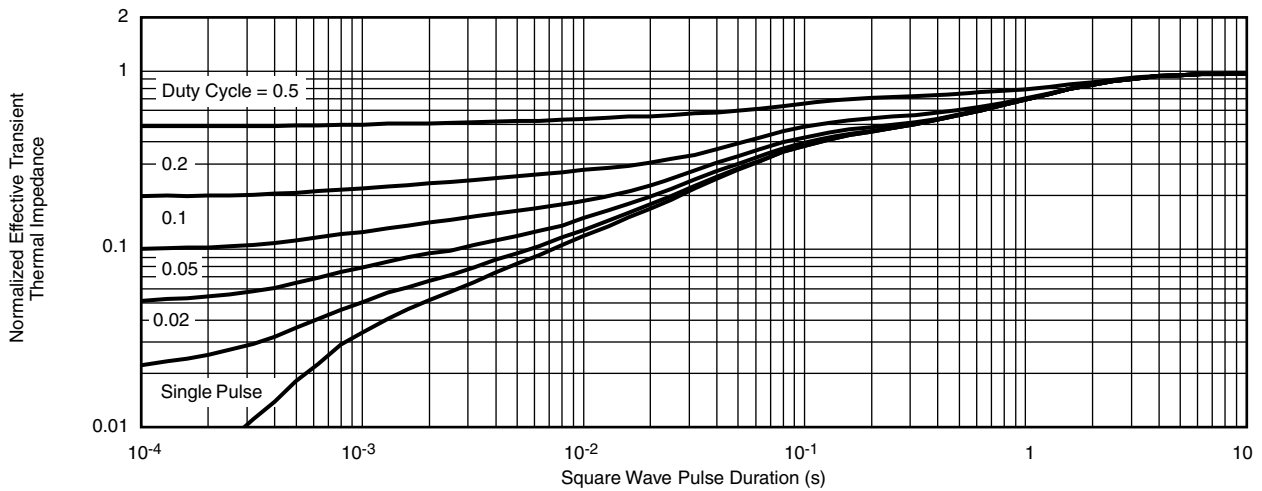
* The power dissipation P_D is based on T_{J (max.)} = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.



TYPICAL CHARACTERISTICS ($T_J = 25\text{ }^\circ\text{C}$, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient

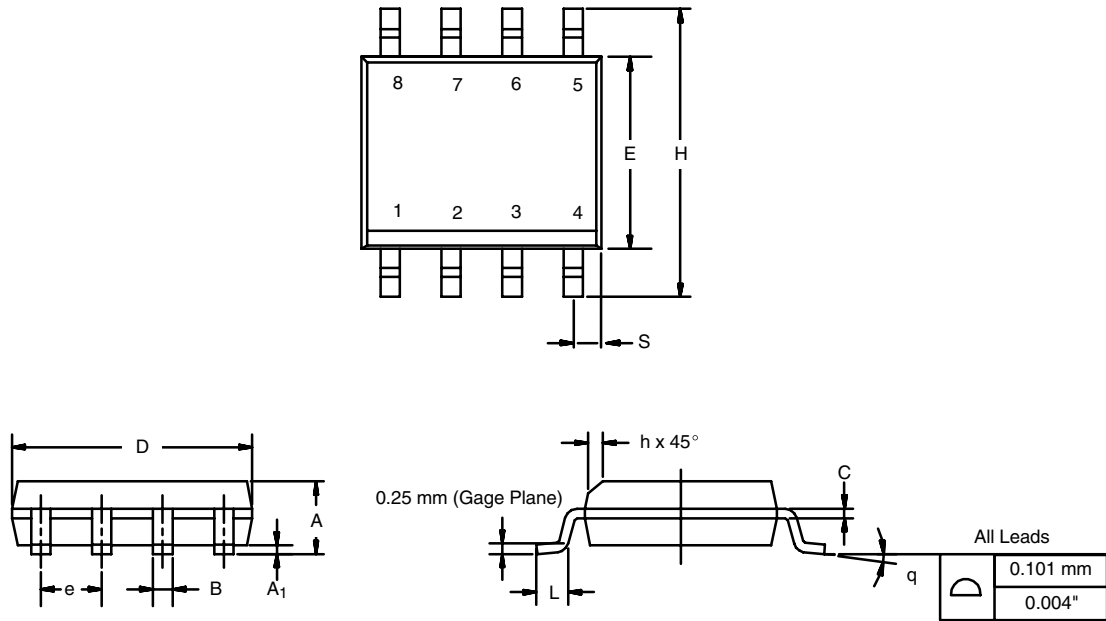


Normalized Thermal Transient Impedance, Junction-to-Foot

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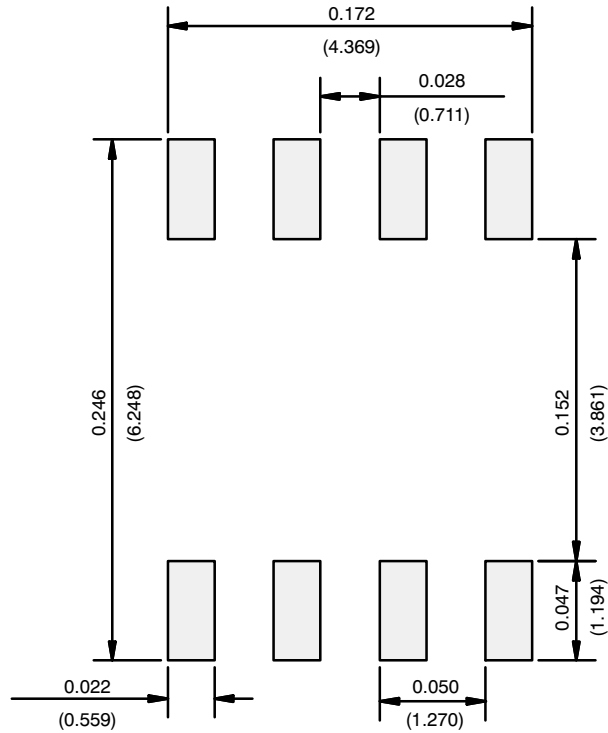
SOIC (NARROW): 8-LEAD

JEDEC Part Number: MS-012



DIM	MILLIMETERS		INCHES	
	Min	Max	Min	Max
A	1.35	1.75	0.053	0.069
A ₁	0.10	0.20	0.004	0.008
B	0.35	0.51	0.014	0.020
C	0.19	0.25	0.0075	0.010
D	4.80	5.00	0.189	0.196
E	3.80	4.00	0.150	0.157
e	1.27 BSC		0.050 BSC	
H	5.80	6.20	0.228	0.244
h	0.25	0.50	0.010	0.020
L	0.50	0.93	0.020	0.037
q	0°	8°	0°	8°
S	0.44	0.64	0.018	0.026
ECN: C-06527-Rev. I, 11-Sep-06				
DWG: 5498				

RECOMMENDED MINIMUM PADS FOR SO-8



Recommended Minimum Pads
Dimensions in Inches/(mm)

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